

| | Type | L # | Hits | Search Text | DBs | Time Stamp | Comments | Error Defin ition | Errors |
|---|------|-----|--------|--|---|---------------------|----------|-------------------------|--------|
| 1 | BRS | L1 | 167198 | etch\$3 same (heat\$3 with substrate or semiconductor or workpiece) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 15:55 | | | 0 |
| 2 | BRS | L2 | 22147 | etch\$3 same (heat\$3 with (substrate or semiconductor or workpiece)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 15:56 | | | 0 |
| 3 | BRS | L3 | 4175 | mask same etch\$3 same (heat\$3 with (substrate or semiconductor or workpiece)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 15:57 | | | 0 |
| 4 | BRS | L4 | 432 | (mask with (Ti or titanium or Al or aluminum or Ta or tantalum or W or tungsten or cobalt or "Co" or Mo or molybdenum)) same etch\$3 same (heat\$3 with (substrate or semiconductor or workpiece)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 16:01 | | | 0 |
| 5 | BRS | L5 | 341 | 4 and @pd<=20001020 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:04 | | | 0 |
| 6 | BRS | L6 | 123 | 5 and 438/\$.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:02 | | | 0 |
| 7 | BRS | L7 | 0 | (rate with erosion with mask) same heat\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:03 | | | 0 |
| 8 | BRS | L8 | 0 | slow\$3 with (rate with erosion with mask) same heat\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:04 | | | 0 |
| 9 | BRS | L9 | 0 | slow\$3 same (rate with erosion with mask) same heat\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:04 | | | 0 |

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|----|------|-----|------|---|---|---------------------|----------|-------------------------|--------|
| 10 | BRS | L10 | 18 | slow\$3 same (rate with erosion) same heat\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:04 | | | 0 |
| 11 | BRS | L11 | 15 | 10 and @pd<=20001020 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:06 | | | 0 |
| 12 | BRS | L12 | 74 | (erosion adj rate) with temperature | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:07 | | | 0 |
| 13 | BRS | L13 | 29 | (erosion adj rate) with (mask andtemperature) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:07 | | | 0 |
| 14 | BRS | L14 | 0 | (erosion adj rate) with (mask and temperature) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:08 | | | 0 |
| 15 | BRS | L15 | 9 | (erosion adj rate) same (mask and temperature) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/15 18:08 | | | 0 |